

>>> SOLDER SPHERES



Thanks to our special manufacturing technique Pfarr solder spheres support all state-of-the-art and high-end applications.

Our Lead-bearing and Lead-free solder spheres are available in standard as well as customised alloy compositions.

KEY FEATURES

- · high sphericity
- excellent surface finish
- · complete reliability
- · tightest tolerances

ADVANTAGES

- · excellent mechanical properties
- · perfect electrical characteristics

APPLICATION FIELDS

- · BGA Ball Grid Array
- · CSP Chip Scale Package

>>> COMMON SOLDER COMPOSITIONS

Alloy	Composition	Melting Temperature	Note
Landal Seal®	Landal Seal®	214 °C	Lead free (RoHS approved)
SAC305	Sn 96.5% Ag 3% Cu 0.5%	217 - 219 °C	Lead free (RoHS approved)
SAC387	Sn 95.5% Ag 3.8% Cu 0.7%	217 °C	Lead free (RoHS approved)
SnPb37	Sn 63% Pb 37%	183 °C	Lead-bearing
PbSn10	Pb 90% Sn 10%	268 - 302 °C	Lead-bearing

Your specific alloy requirements generally available on request.

>>> STANDARD SOLDER SPHERES

Product	Package	
Diameter 0.20 mm (.008 inch)	jars / tape and reel	
Diameter 0.25 mm (.010 inch)	jars / tape and reel	
Diameter 0.30 mm (.012 inch)	jars / tape and reel	
Diameter 0.35 mm (.014 inch)	jars / tape and reel	
Diameter 0.40 mm (.016 inch)	jars / tape and reel	
Diameter 0.45 mm (.018 inch)	jars / tape and reel	
Diameter 0.50 mm (.020 inch)	jars / tape and reel	
Diameter 0.55 mm (.022 inch)	jars / tape and reel	
Diameter 0.60 mm (.024 inch)	jars / tape and reel	
Diameter 0.65 mm (.026 inch)	jars / tape and reel	
Diameter 0.70 mm (.028 inch)	jars / tape and reel	
Diameter 0.76 mm (.030 inch)	jars / tape and reel	
Diameter 0.81 mm (.032 inch)	jars / tape and reel	
Diameter 0.89 mm (.035 inch)	jars / tape and reel	

Packaging: Solder spheres are packed under an inert atmosphere such as Argon gas to safeguard all properties.





PFARR Stanztechnik GmbH D 36419 Buttlar Germany Fon +49 (0) 36967 747- 0 Fax +49 (0) 36967 747- 47

info@pfarr.de www.pfarr.de

